



## Product Change Notification / SYST-12WUIM914

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**Date:**

16-Nov-2021

**Product Category:**

8-bit Microcontrollers

**PCN Type:**

Document Change

**Notification Subject:**

ERRATA - ATmega48A/PA/88A/PA/168A/PA/328/P Silicon Errata and Data Sheet Clarification

**Affected CPNs:**

[SYST-12WUIM914\\_Affected\\_CPN\\_11162021.pdf](#)

[SYST-12WUIM914\\_Affected\\_CPN\\_11162021.csv](#)

**Notification Text:**

SYST-12WUIM914

Microchip has released a new Product Documents for the ATmega48A/PA/88A/PA/168A/PA/328/P Silicon Errata and Data Sheet Clarification of devices. If you are using one of these devices please read the document located at [ATmega48A/PA/88A/PA/168A/PA/328/P Silicon Errata and Data Sheet Clarification](#)

**Notification Status:** Final

**Description of Change:** 1. Added data sheet clarifications:

- Ordering Information
- Package Information

**Impacts to Data Sheet:** None

**Reason for Change:** To Improve Productivity

**Change Implementation Status:** Complete

**Date Document Changes Effective:** 16 Nov 2021

**NOTE:** Please be advised that this is a change to the document only the product has not been changed.

**Markings to Distinguish Revised from Unrevised Devices:** N/A

## **Attachments:**

[ATmega48A/PA/88A/PA/168A/PA/328/P Silicon Errata and Data Sheet Clarification](#)

Please contact your local [Microchip sales office](#) with questions or concerns regarding this notification.

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Affected Catalog Part Numbers (CPN)

ATMEGA48PA-15MZ  
ATMEGA48PA-15MZV01  
ATMEGA48PA-15AZ  
ATMEGA48PA-15AZV03  
ATMEGA88PA-15AZT  
ATMEGA88A-PU  
ATMEGA88PA-PU  
ATMEGA88PA-MMH  
ATMEGA88A-MMH  
ATMEGA88A-MU  
ATMEGA88PA-MU  
ATMEGA88PA-AU  
ATMEGA88A-AU  
ATMEGA88PA-AUA6  
ATMEGA88PA-PN  
ATMEGA88PA-MMN  
ATMEGA88PA-MN  
ATMEGA88PA-AN  
ATMEGA88PA-MMNR  
ATMEGA88PA-MNR  
ATMEGA88PA-ANR  
ATMEGA88PA-MMUR  
ATMEGA88PA-MMHR  
ATMEGA88A-MMHR  
ATMEGA88A-MUR  
ATMEGA88PA-MUR  
ATMEGA88PA-MURA6  
ATMEGA88PA-AUR  
ATMEGA88PA-AURA3  
ATMEGA88A-AUR  
ATMEGA88PA-15MZ  
ATMEGA88PA-15MZV03  
ATMEGA88PA-15MZV04  
ATMEGA88PA-15MZV05  
ATMEGA88PA-15MZV06  
ATMEGA88PA-15MZV07  
ATMEGA88PA-15AZ  
ATMEGA88PA-15AZV01  
ATMEGA88PA-15AZV02  
ATMEGA168PA-15AZT  
ATMEGA168PA-15AZTV02  
ATMEGA168A-PU  
ATMEGA168PA-PU  
ATMEGA168PA-MMH  
ATMEGA168A-MMH  
ATMEGA168PA-MU

ATMEGA168A-MU  
ATMEGA168PA-MUA2  
ATMEGA168PA-AU  
ATMEGA168A-AU  
ATMEGA168PA-PN  
ATMEGA168PA-MN  
ATMEGA168PA-AN  
ATMEGA168PA-MNR  
ATMEGA168PA-ANR  
ATMEGA168PA-MMHR  
ATMEGA168A-MMHR  
ATMEGA168PA-MUR  
ATMEGA168A-MUR  
ATMEGA168PA-MURA2  
ATMEGA168PA-AUR  
ATMEGA168A-AUR  
ATMEGA168PA-15MZ  
ATMEGA168PA-15MZV01  
ATMEGA168PA-15MZV03  
ATMEGA168PA-15MZV04  
ATMEGA168PA-15AZ  
ATMEGA328P-PU  
ATMEGA328-PU  
ATMEGA328P-MMH  
ATMEGA328-MMH  
ATMEGA328P-MU  
ATMEGA328-MU  
ATMEGA328P-MUA2  
ATMEGA328-AU  
ATMEGA328P-AU  
ATMEGA328P-PN  
ATMEGA328P-MN  
ATMEGA328P-AN  
ATMEGA328P-MNR  
ATMEGA328P-ANR  
ATMEGA328P-MMHR  
ATMEGA328-MMHR  
ATMEGA328P-MUR  
ATMEGA328-MUR  
ATMEGA328-AUR  
ATMEGA328P-AUR  
ATMEGA328P-AURA0  
ATMEGA328P-15MZ  
ATMEGA328P-15AZ  
ATMEGA48A-PU  
ATMEGA48PA-PU  
ATMEGA48PA-MMH  
ATMEGA48A-MMH  
ATMEGA48A-MU

ATMEGA48PA-MU  
ATMEGA48A-AU  
ATMEGA48PA-AU  
ATMEGA48PA-PN  
ATMEGA48PA-MMN  
ATMEGA48PA-MN  
ATMEGA48PA-AN  
ATMEGA48PA-MMNR  
ATMEGA48PA-MNR  
ATMEGA48PA-ANR  
ATMEGA48PA-MMHR  
ATMEGA48A-MMHR  
ATMEGA48A-MUR  
ATMEGA48PA-MUR  
ATMEGA48A-AUR  
ATMEGA48PA-AUR  
ATMEGA48PA-AURB0



# ATmega48A/PA/88A/PA/ 168A/PA/328/P

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## Silicon Errata and Data Sheet Clarifications

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### Introduction

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The ATmega48A/PA/88A/PA/168A/PA/328/P devices you have received conform functionally to the current device data sheet ([www.microchip.com/DS40002061](http://www.microchip.com/DS40002061)), except for the anomalies described in this document. The erratas described in this document will likely be addressed in future revisions of the ATmega48A/PA/88A/PA/168A/PA/328/P devices.

**Note:**

- This document summarizes all the silicon errata issues from all revisions of silicon, previous as well as current.

### 1. Silicon Issue Summary

#### Legend

- Erratum is not applicable.
- X Erratum is applicable.

| Peripheral                     | Short Description   | Valid for Silicon Revision |        |              |        |               |        |             |        |        |
|--------------------------------|---|----------------------------|--------|--------------|--------|---------------|--------|-------------|--------|--------|
|                                |   | ATmega48A/PA               |        | ATmega88A/PA |        | ATmega168A/PA |        | ATmega328/P |        |        |
|                                |   | Rev. D (1)                 | Rev. E | Rev. F (1)   | Rev. G | Rev. E (1)    | Rev. L | Rev. A      | Rev. B | Rev. D |
| System Clock and Clock Options | <a href="#">2.2.1. Unstable 32 kHz Oscillator</a>                             | -                          | -      | -            | -      | -             | -      | X           | X      | -      |
| TWI                            | <a href="#">2.3.1. TWI Data Setup Time Can Be Too Short</a>                   | X                          | X      | X            | X      | X             | X      | -           | -      | X      |
| Analog Comparator              | <a href="#">2.4.1. Analog MUX Can Be Turned Off When Setting the ACME Bit</a> | X                          | X      | X            | X      | X             | X      | X           | X      | X      |

#### Note:

1. This revision is the initial release of the silicon.

The following silicon revisions were never released to production:

- ATmega168A/PA
  - Rev. F-K
- ATmega328/P
  - Rev. C

## 2. Silicon Errata Issues

### 2.1 Errata Details

- Erratum is not applicable.
- X Erratum is applicable.

### 2.2 System Clock and Clock Options

#### 2.2.1 Unstable 32 kHz Oscillator

The 32 kHz oscillator does not work as a system clock and if it used as an asynchronous timer, it is inaccurate.

**Work around**

None.

**Affected Silicon Revisions**

| ATmega48A/PA |        |  |
|--------------|--------|--|
| Rev. D       | Rev. E |  |
| -            | -      |  |

| ATmega88A/PA |        |
|--------------|--------|
| Rev. F       | Rev. G |
| -            | -      |

| ATmega168A/PA |        |
|---------------|--------|
| Rev. E        | Rev. L |
| -             | -      |

| ATmega328/P |        |        |
|-------------|--------|--------|
| Rev. A      | Rev. B | Rev. D |
| X           | X      | -      |

### 2.3 TWI - Two-Wire Interface

#### 2.3.1 TWI Data Setup Time Can Be Too Short

When running the device as a TWI slave with a system clock above 2 MHz, the data setup time for the first bit after ACK may, in some cases, be too short. This may cause a false start or stop condition on the TWI line.

**Work around**

Insert a delay between setting TWDR and TWCR.



### Affected Silicon Revisions

| ATmega48A/PA |  |        |
|--------------|--|--------|
| Rev. D       |  | Rev. E |
| X            |  | X      |

| ATmega88A/PA |        |
|--------------|--------|
| Rev. F       | Rev. G |
| X            | X      |

| ATmega168A/PA |        |
|---------------|--------|
| Rev. E        | Rev. L |
| X             | X      |

| ATmega328/P |        |        |
|-------------|--------|--------|
| Rev. A      | Rev. B | Rev. D |
| -           | -      | X      |

## 2.4 AC - Analog Comparator

### 2.4.1 Analog MUX Can Be Turned Off When Setting the ACME Bit

If the ACME (Analog Comparator Multiplexer Enabled) bit in ADCSRB is set while MUX3 in ADMUX is '1' (ADMUX[3:0]=1xxx), all MUXs are turned off until the ACME bit is cleared.

#### Work around

Clear the MUX3 bit before setting the ACME bit.

### Affected Silicon Revisions

| ATmega48A/PA |  |        |
|--------------|--|--------|
| Rev. D       |  | Rev. E |
| X            |  | X      |

| ATmega88A/PA |        |
|--------------|--------|
| Rev. F       | Rev. G |
| X            | X      |

| ATmega168A/PA |        |
|---------------|--------|
| Rev. E        | Rev. L |
| X             | X      |

| ATmega328/P |        |        |
|-------------|--------|--------|
| Rev. A      | Rev. B | Rev. D |
| X           | X      | X      |

### 3. Data Sheet Clarifications

The following typographic corrections and clarifications are to be noted for the latest version of the device data sheet ([www.microchip.com/DS40002061](http://www.microchip.com/DS40002061)).

**Note:** Corrections are shown in **bold**. Where possible, the original bold text formatting has been removed for clarity.

#### 3.1 Ordering Information

A clarification has been made to tables titled 'Package Type' for all devices documented in the data sheet:

- A note to the 32M1-A row was added informing that the package type can be delivered in two different styles

| Package Type          |   |
|-----------------------|---|
| 32A                   | 32-lead, (1.0 mm) Plastic Thin Quad Flat Package (TQFP)                                 |
| 28M1                  | 28-pad, 4 x 4 x 1.0 body, Lead Pitch 0.45 mm Very Thin Plastic Quad Flat No-Lead (VQFN) |
| 32M1-A <sup>(1)</sup> | 32-pad, 5 x 5 x 1.0 body, Lead Pitch 0.50 mm Thin Plastic Quad Flat No-Lead (VQFN)      |
| 28P3                  | 28-lead, 0.300" Wide, Skinny Plastic Dual Inline Package (SPDIP)                        |

1. **This package type can be delivered with two different styles with reference numbers 'C04-21400' (punched) and 'C04-21395' (sawn) as shown in section 3.2.1 - 32M1-A. For PCB layouts, it is recommended to take both *recommended land patterns* into consideration.**

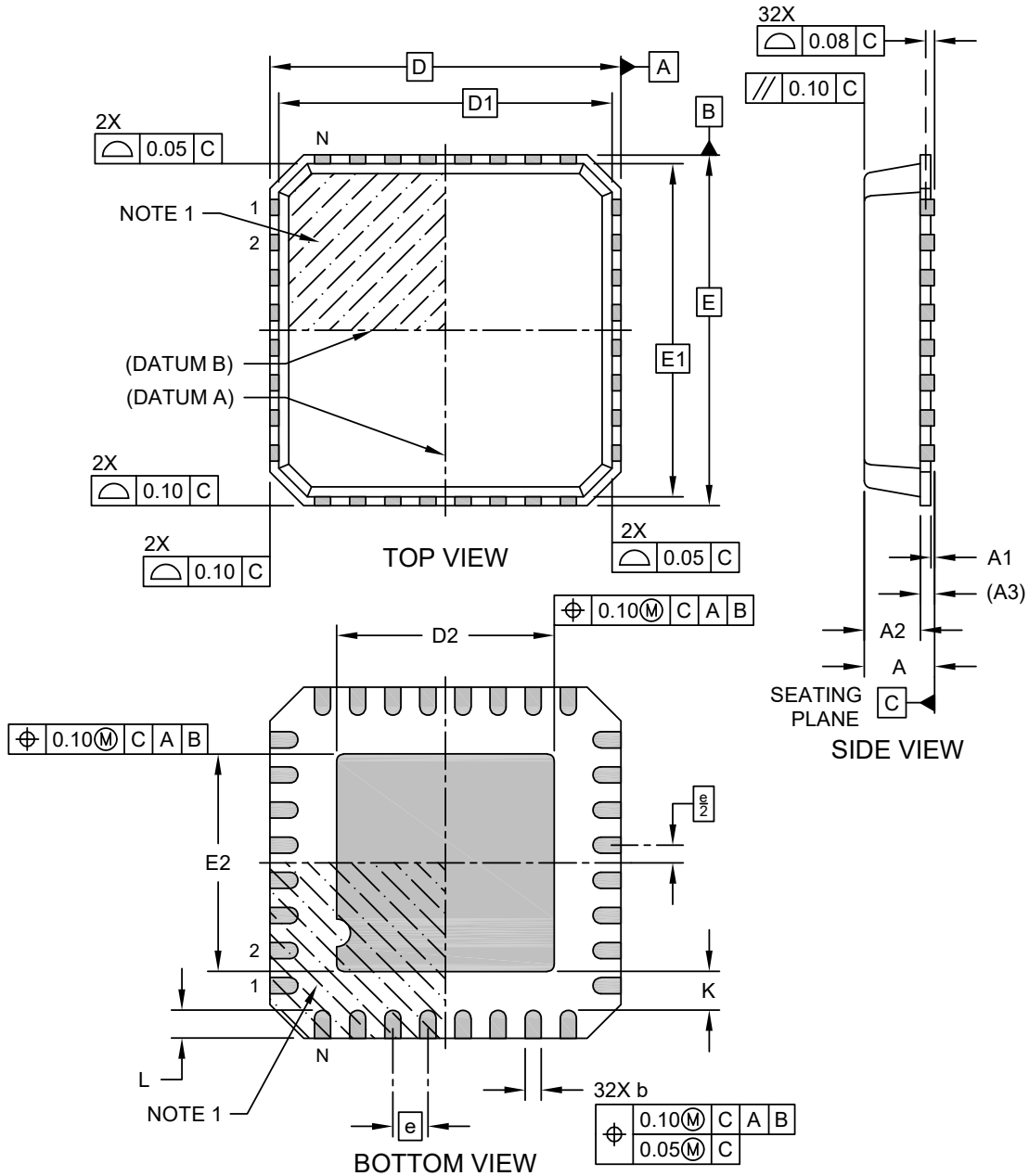
#### 3.2 Package Information

A clarification about the other package style available for package type 32M1-A has been added to the 32M1-A section.

### 3.2.1 32M1-A

#### 32-Lead Thin Plastic Quad Flat, No Lead Package (S4B) - 5x5 mm Body [VQFN] Punch Singulated; 3.10x3.10 mm Exposed Pad

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



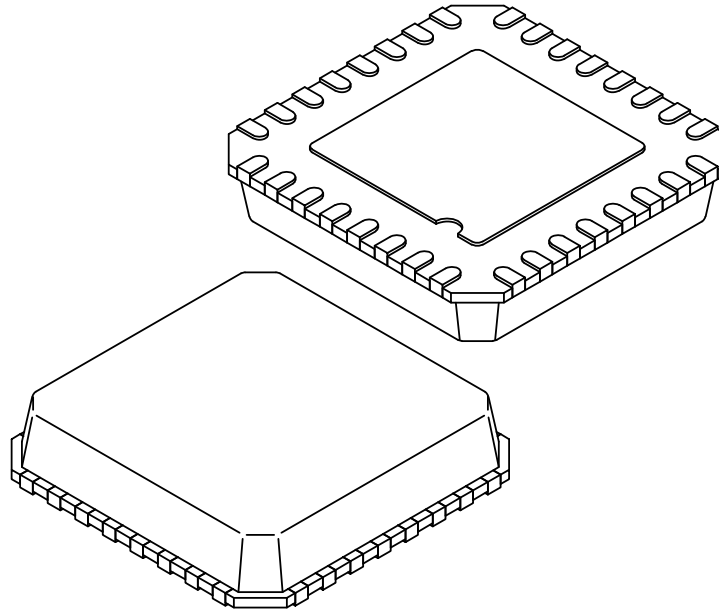
Microchip Technology Drawing C04-21400 Rev B Sheet 1 of 2

# ATmega48A/PA/88A/PA/168A/PA/328/P

## Data Sheet Clarifications

### 32-Lead Thin Plastic Quad Flat, No Lead Package (S4B) - 5x5 mm Body [VQFN] Punch Singulated; 3.10x3.10 mm Exposed Pad

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



|                         |    | Units | MILLIMETERS |      |      |
|-------------------------|----|-------|-------------|------|------|
| Dimension Limits        |    |       | MIN         | NOM  | MAX  |
| Number of Terminals     | N  |       | 32          |      |      |
| Pitch                   | e  |       | 0.50 BSC    |      |      |
| Overall Height          | A  |       | 0.80        | 0.85 | 1.00 |
| Standoff                | A1 |       | 0.00        | 0.02 | 0.05 |
| Mold Cap Thickness      | A2 |       | -           | 0.65 | 0.70 |
| Terminal Thickness      | A3 |       | 0.20 REF    |      |      |
| Overall Length          | D  |       | 5.00 BSC    |      |      |
| Mold Cap Length         | D1 |       | 4.75 BSC    |      |      |
| Exposed Pad Length      | D2 |       | 2.95        | 3.10 | 3.25 |
| Overall Width           | E  |       | 5.00 BSC    |      |      |
| Mold Cap Width          | E1 |       | 4.75 BSC    |      |      |
| Exposed Pad Width       | E2 |       | 2.95        | 3.10 | 3.25 |
| Terminal Width          | b  |       | 0.18        | 0.23 | 0.30 |
| Terminal Length         | L  |       | 0.30        | 0.40 | 0.50 |
| Terminal-to-Exposed-Pad | K  |       | 0.20        | -    | -    |

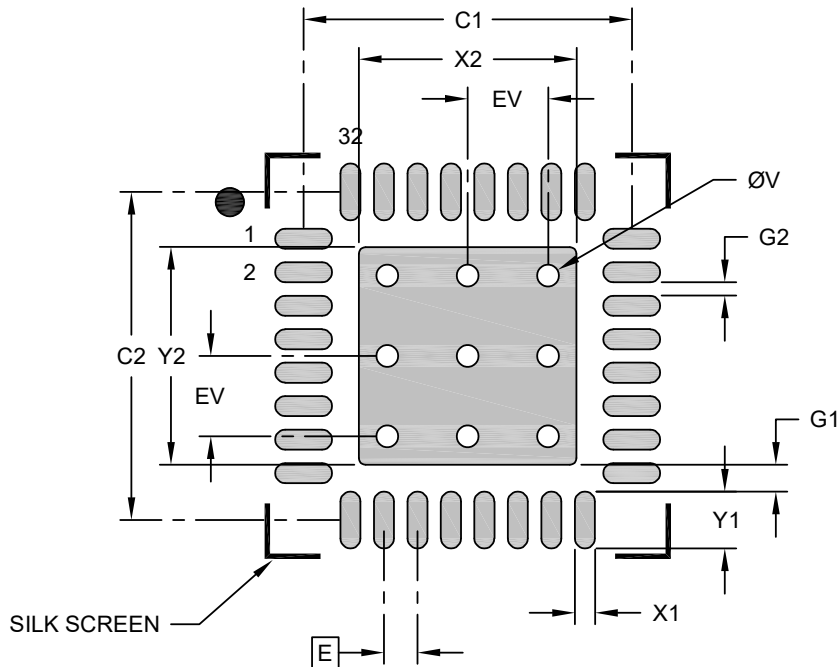
**Notes:**

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Package is punch singulated
3. Dimensioning and tolerancing per ASME Y14.5M  
BSC: Basic Dimension. Theoretically exact value shown without tolerances.  
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-21400 Rev B Sheet 2 of 2

### 32-Lead Thin Plastic Quad Flat, No Lead Package (S4B) - 5x5 mm Body [VQFN] Punch Singulated; 3.10x3.10 mm Exposed Pad

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



#### RECOMMENDED LAND PATTERN

| Dimension Limits                 | Units | MILLIMETERS |      |      |
|----------------------------------|-------|-------------|------|------|
|                                  |       | MIN         | NOM  | MAX  |
| Contact Pitch                    | E     | 0.50 BSC    |      |      |
| Optional Center Pad Width        | X2    |             |      | 3.25 |
| Optional Center Pad Length       | Y2    |             |      | 3.25 |
| Contact Pad Spacing              | C1    |             | 4.90 |      |
| Contact Pad Spacing              | C2    |             | 4.90 |      |
| Contact Pad Width (X32)          | X1    |             |      | 0.30 |
| Contact Pad Length (X32)         | Y1    |             |      | 0.85 |
| Contact Pad to Center Pad (X32)  | G1    | 0.40        |      |      |
| Contact Pad to Contact Pad (X28) | G2    | 0.20        |      |      |
| Thermal Via Diameter             | V     |             | 0.33 |      |
| Thermal Via Pitch                | EV    |             | 1.20 |      |

**Notes:**

- Dimensioning and tolerancing per ASME Y14.5M  
BSC: Basic Dimension. Theoretically exact value shown without tolerances.
- For best soldering results, thermal vias, if used, should be filled or tented to avoid solder loss during reflow process

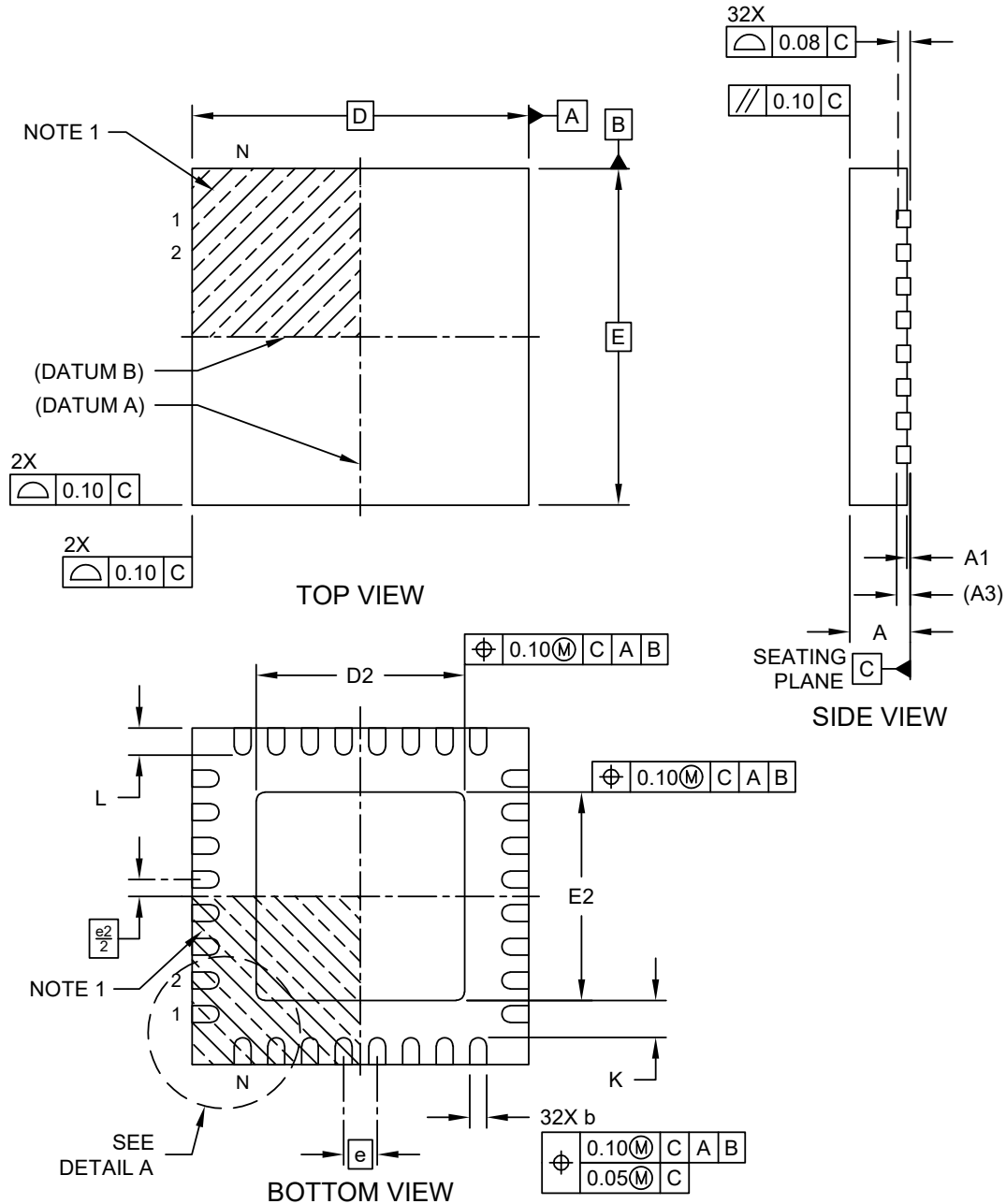
Microchip Technology Drawing C04-23400 Rev B

# ATmega48A/PA/88A/PA/168A/PA/328/P

## Data Sheet Clarifications

### 32-Lead Very Thin Plastic Quad Flat, No Lead Package (UBB) - 5x5x0.9 mm Body [VQFN] With 3.1x3.1 mm Exposed Pad; Atmel Legacy Global Package Code ZMF

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



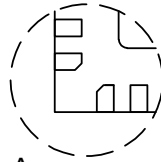
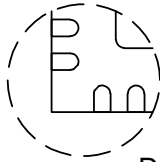
Microchip Technology Drawing C04-21395-UBB Rev C Sheet 1 of 2

# ATmega48A/PA/88A/PA/168A/PA/328/P

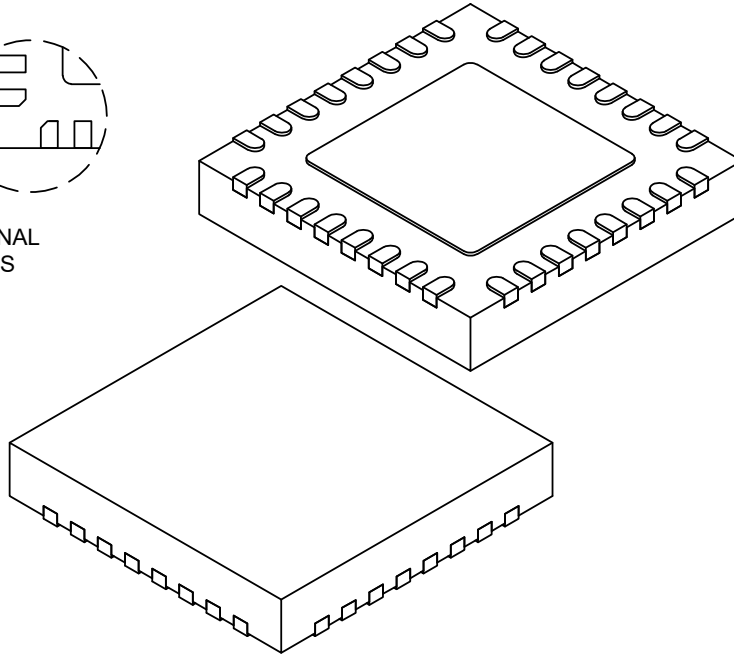
## Data Sheet Clarifications

### 32-Lead Very Thin Plastic Quad Flat, No Lead Package (UBB) - 5x5x0.9 mm Body [VQFN] With 3.1x3.1 mm Exposed Pad; Atmel Legacy Global Package Code ZMF

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



**DETAIL A**  
ALTERNATE TERMINAL  
CONFIGURATIONS



| Dimension Limits        | Units | MILLIMETERS |      |      |
|-------------------------|-------|-------------|------|------|
|                         |       | MIN         | NOM  | MAX  |
| Number of Terminals     | N     | 32          |      |      |
| Pitch                   | e     | 0.50 BSC    |      |      |
| Overall Height          | A     | 0.80        | 0.85 | 0.90 |
| Standoff                | A1    | 0.00        | 0.02 | 0.05 |
| Terminal Thickness      | A3    | 0.203 REF   |      |      |
| Overall Length          | D     | 5.00 BSC    |      |      |
| Exposed Pad Length      | D2    | 3.00        | 3.10 | 3.20 |
| Overall Width           | E     | 5.00 BSC    |      |      |
| Exposed Pad Width       | E2    | 3.00        | 3.10 | 3.20 |
| Terminal Width          | b     | 0.18        | 0.25 | 0.30 |
| Terminal Length         | L     | 0.30        | 0.40 | 0.50 |
| Terminal-to-Exposed-Pad | K     | 0.20        | -    | -    |

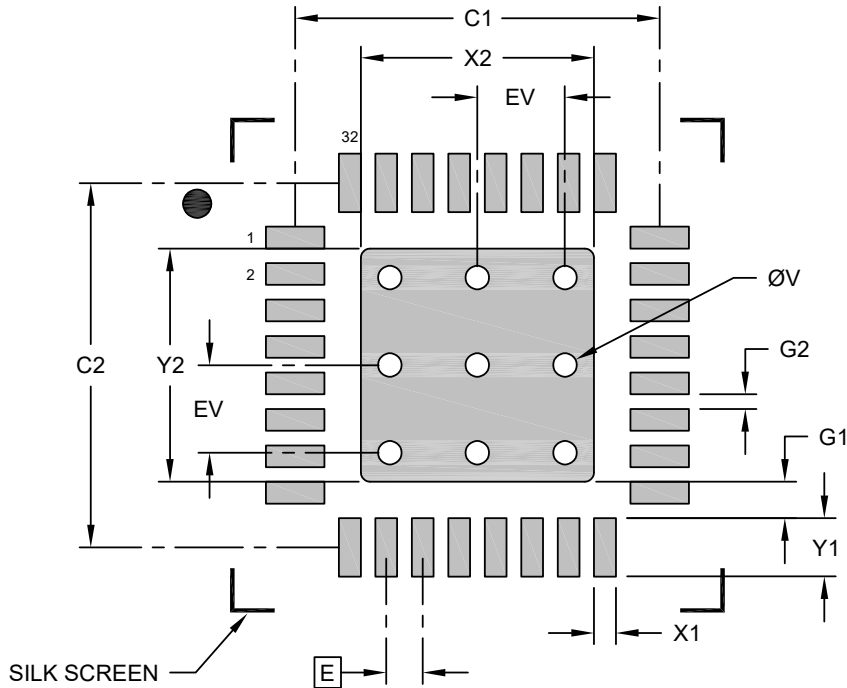
**Notes:**

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Package is saw singulated
3. Dimensioning and tolerancing per ASME Y14.5M  
BSC: Basic Dimension. Theoretically exact value shown without tolerances.  
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-21395-UBB Rev C Sheet 2 of 2

### 32-Lead Very Thin Plastic Quad Flat, No Lead Package (UBB) - 5x5x0.9 mm Body [VQFN] With 3.1x3.1 mm Exposed Pad; Atmel Legacy Global Package Code ZMF

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



#### RECOMMENDED LAND PATTERN

| Dimension Limits                 | Units | MILLIMETERS |      |      |
|----------------------------------|-------|-------------|------|------|
|                                  |       | MIN         | NOM  | MAX  |
| Contact Pitch                    | E     | 0.50 BSC    |      |      |
| Center Pad Width                 | X2    |             |      | 3.20 |
| Center Pad Length                | Y2    |             |      | 3.20 |
| Contact Pad Spacing              | C1    |             | 5.00 |      |
| Contact Pad Spacing              | C2    |             | 5.00 |      |
| Contact Pad Width (X32)          | X1    |             |      | 0.30 |
| Contact Pad Length (X32)         | Y1    |             |      | 0.80 |
| Contact Pad to Center Pad (X32)  | G1    | 0.20        |      |      |
| Contact Pad to Contact Pad (X28) | G2    | 0.20        |      |      |
| Thermal Via Diameter             | V     |             | 0.33 |      |
| Thermal Via Pitch                | EV    |             | 1.20 |      |

**Notes:**

1. Dimensioning and tolerancing per ASME Y14.5M  
BSC: Basic Dimension. Theoretically exact value shown without tolerances.
2. For best soldering results, thermal vias, if used, should be filled or tented to avoid solder loss during reflow process

Microchip Technology Drawing C04-23395-UBB Rev C



## 4. Document Revision History

**Note:** The data sheet clarification document revision is independent of the die revision and the device variant (last letter of the ordering number).

### 4.1 Revision History

| Doc Rev. | Date    | Comments   |
|----------|---------|--|
| B        | 11/2021 | Added data sheet clarifications: <ul style="list-style-type: none"><li>• <a href="#">Ordering Information</a></li><li>• <a href="#">Package Information</a></li></ul>  |
| A        | 09/2020 | Initial document release. <ul style="list-style-type: none"><li>• Content moved from the data sheet and restructured to the new document template</li><li>• Updated the die revision list to reflect die revisions in production</li></ul> |

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